



100 S. Roosevelt Avenue Chandler, AZ 85226 Tel: 480-961-1382, Fax: 480-961-4533 www.rogerscorp.com

Data Sheet

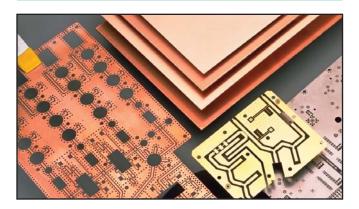
RT/duroid® 6006/6010LM High Frequency Laminates

Features:

- High dielectric constant for circuit size reduction.
- Low loss. Ideal for operating at X-band or below.
- Low Z-axis expansion for RT/duroid 6010LM.
 Provides reliable plated through holes in multilayer boards.
- Low moisture absorption for RT/duroid 6010LM. Reduces effects of moisture on electrical loss.
- Tight ε_{r} and thickness control for repeatable circuit performance.

Some Typical Applications:

- Space Saving Circuitry
- Patch Antennas
- Satellite Communications Systems
- Power Amplifiers
- Aircraft Collision Avoidance Systems
- Ground Radar Warning Systems



RT/duroid® 6006/6010LM microwave laminates are ceramic-PTFE composites designed for electronic and microwave circuit applications requiring a high dielectric constant. RT/duroid 6006 laminate is available with a dielectric constant value of 6.15 and RT/duroid 6010LM laminate has a dielectric constant of 10.2.

RT/duroid 6006/6010LM microwave laminates feature ease of fabrication and stability in use. They have tight dielectric constant and thickness control, low moisture absorption, and good thermal mechanical stability.

Laminates are supplied clad both sides with $\frac{1}{4}$ to 2 oz./ft. 2 (8 to 70 μ m) electrodeposited (ED) copper foil. Cladding with rolled copper foil is also available. Thick aluminum, brass, or copper plate on one side may be specified.

Standard tolerance dielectric thicknesses of 0.010", 0.025", 0.050", 0.075", and 0.100" (0.254, 0.635, 1.270, 1.905, 2.54 mm) are available. When ordering RT/duroid 6006 and RT/duroid 6010LM laminates, it is important to specify dielectric thickness, electrodeposited or rolled, and weight of copper foil required.

The information in this data sheet is intended to assist you in designing with Rogers' circuit material laminates. It is not intended to and does not create any warranties express or implied, including any warranty of merchantability or fitness for a particular purpose or that the results shown on this data sheet will be achieved by a user for a particular purpose. The user should determine the suitability of Rogers' circuit material laminates for each application.

Typical Values

RT/duroid® 6006, RT/duroid 6010LM Laminates

Property	Typical Value [2]					
	RT/duroid® 6006	RT/duroid 6010.2LM	Direction	Units [1]	Condition	Test Method
Dielectric Constant ε _r	6.15± 0.15	10.2 ± 0.25	Z		10 GHz/A	IPC-TM-650 2.5.5.5
Dissipation Factor, $\tan\delta$	0.0027	0.0023	Z		10 GHz/A	IPC-TM-650 2.5.5.5
Thermal Coefficient of ϵ_{r}	-410	-425	Z	ppm/°C	-50 to 170°C	IPC-TM-650 2.5.5.5
Surface Resistivity	7X10 ⁷	5X10 ⁶		Mohm	Α	IPC 2.5.17.1
Volume Resistivity	2X10 ⁷	5X10⁵		Mohm•cm	А	IPC 2.5.17.1
Youngs' Modulus			•	•	•	
under tension	627 (91) 517 (75)	931 (135) 559 (81)	X Y	MPa (kpsi)	А	- ASTM D638 (0.1/min. strain rate)
ultimate stress	20 (2.8) 17 (2.5)	17 (2.4) 13 (1.9)	X Y	MPa (kpsi)	А	
ultimate strain	12 to 13 4 to 6	9 to 15 7 to 14	X Y	%	А	
Youngs' Modulus						ASTM D695 (0.05/min. strain rate)
under compression	1069 (155)	2144 (311)	Z	MPa (kpsi)	А	
ultimate stress	54 (7.9)	47 (6.9)	Z	MPa (kpsi)	А	
ultimate strain	33	25	Z	%		
Flexural Modulus	2634 (382) 1951 (283)	4364 (633) 3751 (544)	Х	MPa (kpsi)	А	ASTM D790
ultimate stress	38 (5.5)	36 (5.2) 32 (4.4)	X Y	MPa (kpsi)	А	
Deformation under load	0.33 2.10	0.26 1.37	Z Z	%	24 hr/ 50°C/7MPa 24 hr/150°C/7MPa	ASTM D621
Moisture Absorption	0.05	0.05		%	24 hr/23°C, 0.050" (1.27mm) thick	IPC-TM-650, 2.6.2.1
Density	2.7	3.1				ASTM D792
Thermal Conductivity	0.49	0.78		W/m/K	23 to 100°C	ASTM D2214, Modified
Thermal Expansion	47 34, 117	24 24,47	X Y,Z	ppm/°C	0 to 100°C	ASTM 3386 (5K/min)
Td	500	500		°C TGA		ASTM D3850
Specific Heat	0.97 (0.231)	1.00 (0.239)		J/g/K (BTU/lb/°F)		Calculated
Copper Peel	14.3 (2.5)	12.3 (2.1)		pli (N/mm)	after solder float	IPC-TM-650 2.4.8
Flammability Rating	94V-0	94V-0				UL
Lead-Free Process Compatible	Yes	Yes				

STANDARD THICKNESS:	STANDARD PANEL SIZE:	STANDARD COPPER CLADDING:
0.010" (0.254mm)	10" X 10" (254 X 254mm)	1/4 oz. (8 μm) electrodeposited copper foil.
0.025" (0.64mm)	10" X 20" (254 X 508mm)	½ oz. (17μm), 1 oz. (35μm), 2 oz. (70μm) elec-
0.050" (1.27mm)	20" X 20" (508 X 508mm)	trodeposited and rolled copper foil.
0.075" (1.90mm)		Heavy metal claddings are available. Contact
0.100" (2.50mm)		Rogers Customer Service.

CONTACT INFORMATION:

USA:	Rogers Advanced Circuit Materials	Tel: 480-961-1382	Fax: 480-961-4533
Belgium:	Rogers NV - Gent	Tel: 32-9-2353611	Fax: 32-9-2353658
Japan:	Rogers Japan Inc.	Tel: 81-3-5200-2700	Fax: 81-3-5200-0571
Taiwan:	Rogers Taiwan Inc.	Tel: 886-2-86609056	Fax: 886-2-86609057
Korea:	Rogers Korea Inc.	Tel: 82-31-716-6112	Fax: 82-31-716-6208
Singapore:	Rogers Technologies Singapore Inc.	Tel: 65-747-3521	Fax: 65-747-7425
China:	Rogers (Shanghai) International Trading Co., Ltd	Tel: 86-21-63916088	Fax: 86-21-63915060

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^[1] SI unit given first with other frequently used units in parentheses.
[2] References: APR4022.33 DJS 4019.27-32, Internal TR 2610. Tests were at 23°C unless otherwise noted. Typical values should not be used for specification limits.
[3] Dielectric constant is based on .025 dielectric thickness, one ounce electrideposited copper on two sides.

Typical values are a representation of an average value for the population of the property. For specification values contact Rogers Corporation.